

Description

The SiT9356 is a ruggedized ultra-low jitter differential ApexMEMS® oscillator engineered for military and aerospace applications. It delivers the most stable timing under environmental stressors such as shock, vibration, high heat, rapid thermal transients, and power supply noise.

In addition to standard differential signal types, a unique FlexSwing™ output-driver performs like LVPECL and provides independent control of voltage swing and DC offset to simplify interfacing with chipsets having non-standard input voltage requirements and eliminate all external source-bias resistors. The device also integrates multiple on-chip regulators to filter power supply noise, eliminating the need for an external dedicated LDO.

The SiT9356 is factory programmed for specific combinations of frequency, stability, output signaling, voltage, and output enable functionality. Programmability enables SiTime to deliver optimized clock configurations while eliminating long lead times and customization costs associated with quartz devices where each combination is custom built.

The wide frequency range and programmability makes this device ideal for communications, networking, and military and aerospace applications that require a variety of frequencies and operate in noisy environments.

Refer to [Manufacturing Notes](#) for proper reflow profile, tape and reel dimension, and other manufacturing related information.

Block Diagram

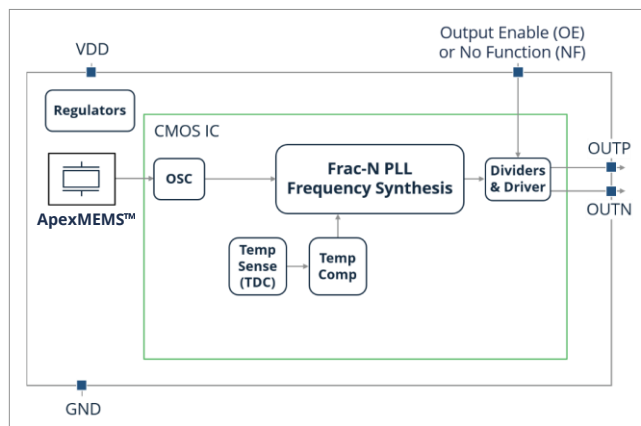


Figure 1. SiT9356 Block Diagram

Features

- 0.04 or 0.1 ppb/g acceleration sensitivity for harsh environments.
- Frequencies between 1 MHz and 220 MHz accurate to 6 decimal places. See [Table 2](#) for information.
(For frequencies above 220 MHz, refer to [SiT9357](#) datasheet)
- 150 fs RMS typical phase jitter, 12 kHz to 20 MHz
- 9 fs/mV typical PSNR
- LVPECL, LVDS, HCSL, Low-power HCSL, and FlexSwing signaling options
- ± 20 , ± 30 and ± 50 ppm frequency stabilities
- Wide temperature range (-55°C to 125°C)
- AEC-Q100 qualified
- Factory programmable options for low lead time
- 1.8 V, 2.5 V, 3.3 V, and wide continuous power supply voltage range options
- 2 x 1.6, 2.5 x 2, 3.2 x 2.5 mm x mm package

Applications

- Avionics
- Military networking equipment
- Advanced displays
- Optical modules
- Coherent optics
- Server and storage systems
- Broadcast Video

Package Pinout

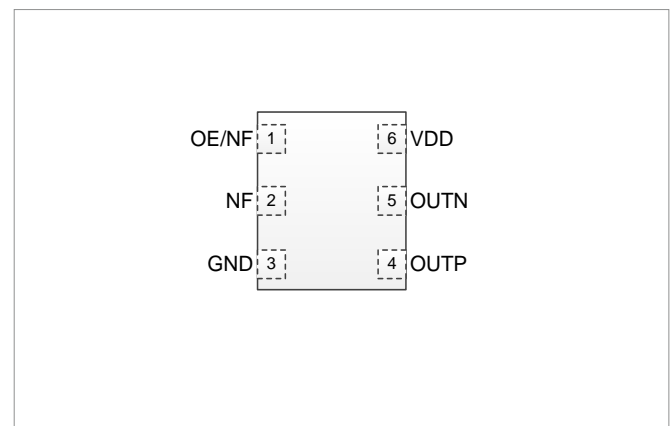


Figure 2. Pin Assignments (Top view)
(Refer to [Table 16](#) for Pin Descriptions)

Ordering Information

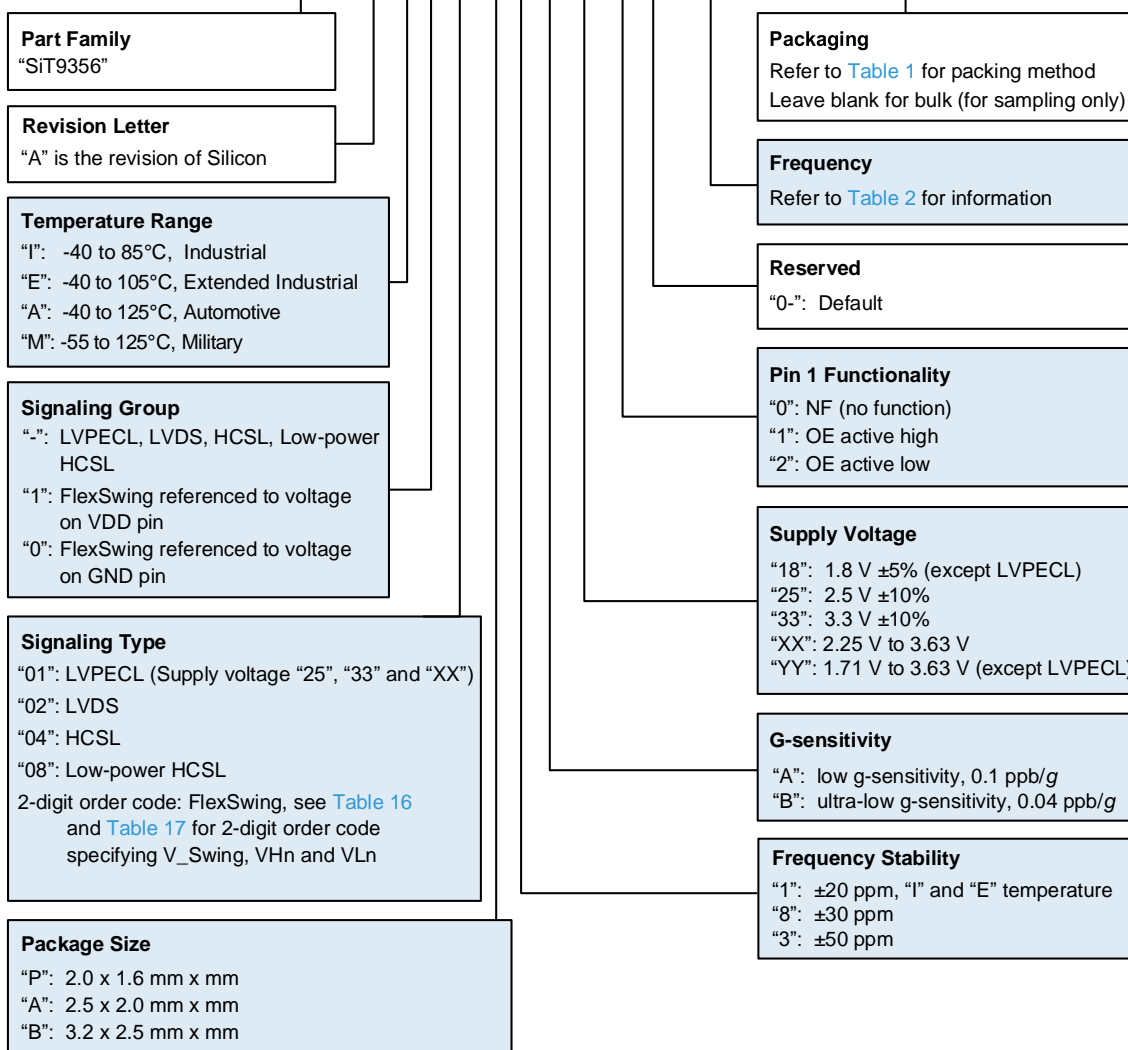
SiT9356A**M-01B3A3310-125.000000D**

Table 1. Ordering Codes for Supported Tape & Reel Packing Method

Device Size (mm x mm)	8 mm T&R (3ku)	8 mm T&R (1ku)	8 mm T&R (250u)
2.0 x 1.6	D	E	G
2.5 x 2.0	D	E	G
3.2 x 2.5	D	E	G

Table 2. Released Frequencies

10.000000 MHz	20.000000 MHz	25.000000 MHz	26.000000 MHz	27.000000 MHz	30.720000 MHz	38.400000 MHz
40.000000 MHz	48.000000 MHz	50.000000 MHz	53.125000 MHz	61.440000 MHz	62.500000 MHz	63.000000 MHz
70.656000 MHz	72.000000 MHz	74.250000 MHz	75.000000 MHz	78.125000 MHz	80.000000 MHz	80.566406 MHz
81.000000 MHz	85.000000 MHz	98.304000 MHz	100.000000 MHz	100.663296 MHz	101.250000 MHz	106.250000 MHz
108.000000 MHz	114.285000 MHz	120.000000 MHz	121.109000 MHz	122.880000 MHz	125.000000 MHz	125.904000 MHz
128.000000 MHz	129.600000 MHz	133.330000 MHz	133.333000 MHz	133.333330 MHz	133.333333 MHz	135.000000 MHz
144.000000 MHz	148.500000 MHz	150.000000 MHz	153.600000 MHz	155.520000 MHz	156.250000 MHz	159.375000 MHz
160.000000 MHz	161.1328125 MHz	161.132813 MHz	162.000000 MHz	162.259615 MHz	165.000000 MHz	166.000000 MHz
166.015625 MHz	166.628571 MHz	166.666000 MHz	166.666666 MHz	167.772160 MHz	170.000000 MHz	200.000000 MHz
206.250000 MHz	212.500000 MHz	Contact SiTime for other Frequencies				

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Electrical Characteristics

All Min and Max limits in the Electrical Characteristics tables are specified over operating temperature and rated operating voltage with standard output termination shown in the termination diagrams. Typical values are at 25°C and nominal supply voltage. See [Test Circuit Diagrams](#) for the test setups used with each signaling type.

Table 3. Electrical Characteristics – Common to All Output Signaling Types

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Frequency Range						
Output Frequency Range	f	1	–	220.000000	MHz	Refer to Table 2 for the list of supported frequencies. For other frequencies, contact SiTime
Frequency Stability						
Frequency Stability	F_stab	–	–	±20	ppm	Frequency ordering code “1” -40°C to +105°C (Temperature Ordering Codes “I” and “E”) Inclusive of initial tolerance, operating temperature, rated power supply voltage, load variation of 2 pF ±10%, and 10 years aging at 85°C
		–	–	±30	ppm	Frequency ordering code “8” -40°C to +105°C (Temperature Ordering Codes “I” and “E”) -40°C to +105°C, ± 50 ppm for +105°C to +125°C (Temperature Ordering Code “A”) -55°C to +105°C, ± 50 ppm for +105°C to +125°C (Temperature Ordering Code “M”) Inclusive of initial tolerance, operating temperature, rated power supply voltage, load variation of 2 pF ± 10%, and 10 years aging at 85°C
		–	–	±50	ppm	Frequency ordering code “2” Inclusive of initial tolerance, operating temperature, rated power supply voltage, load variation of 2 pF ± 10%, and 10 years aging at 85°C
10 Year Aging	F_10y	–	±0.7	2.3	ppm	Ambient temperature of 85°C
Rugged Characteristics						
Acceleration (g) sensitivity, Gamma Vector	F-g	–	–	0.04	ppb/g	G-sensitivity ordering code “B” Ultra-Low sensitivity grade; total gamma over 3 axes; 330 Hz to 1.9kHz, 20g, MIL-PRF-55310, section 4.8.18.3.1.
		–	–	0.1	ppb/g	G-sensitivity ordering code “A” Low sensitivity grade; total gamma over 3 axes; 330 Hz to 1.9kHz, 20g, MIL-PRF-55310, section 4.8.18.3.1.
Temperature Range						
Operating Temperature Range	T_use	-40	–	+85	°C	Industrial, ambient temperature, “I” ordering code
		-40	–	+105	°C	Extended industrial, ambient temperature, “E” ordering code
		-40	–	+125	°C	Automotive, ambient temperature, “A” ordering code
		-55	–	+125	°C	Military, ambient temperature, “M” ordering code
Supply Voltage						
Supply Voltage	Vdd	1.71	–	3.63	V	Voltage-supply order code “YY”, Except for LVPECL
		2.25	–	3.63	V	Voltage-supply order code “XX”
		1.71	1.80	1.89	V	Voltage-supply order code “18”. Except for LVPECL
		2.25	2.50	2.75	V	Voltage-supply order code “25”
		2.97	3.30	3.63	V	Voltage-supply order code “33”

Table 3. Electrical Characteristics – Common to All Output Signaling Types (Continued)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Input Characteristics						
Input Voltage High	V _{IH}	70%	–	–	V _{dd}	Logic High function for Pin 1
Input Voltage Low	V _{IL}	–	–	30%	V _{dd}	Logic High function for Pin 1
Input Pull-up/Pull-down Impedance	Z _{in}	–	120	–	kΩ	Pin 1 for OE function
Output Characteristics						
Duty Cycle	DC	48	–	52	%	See Figure 15 for waveform.
Startup, OE and SE Timing						
Startup Time	T _{start}	–	1.2	2	ms	Measured from the time V _{dd} reaches its rated minimum value
Output Enable Time 1	T _{oe}	–	–	100+3 clock cycles	ns	For all signaling types except Low-Power HCSL. Measured from the time OE pin toggles to enable logic level to the time clock pins reach 90% of final swing. See Figure 21 for waveform.
Output Enable Time 2	T _{oe}	–	–	500+3 clock cycles	ns	For Low-Power HCSL signaling type. Measured from the time OE pin toggles to enable logic level to the time clock pins reach 90% of final swing. See Figure 21 for waveform.
Output Disable Time	T _{od}	–	–	100+3 clock cycles	ns	Measured from the time OE pin toggles to disable logic level to the last clock edge. See Figure 22 for waveform.
Jitter and Phase Noise, measured at f = 155.52 MHz						
RMS Phase Jitter (random)	T _{phj}	–	150	200	fs	12 kHz to 20 MHz offset frequency integration bandwidth. Contact SiTime for <100 fs rms jitter
Spurious Phase Noise	PN _{spur}	–	-88	-83.5	dBc	12 kHz to 20 MHz offset frequency range
RMS Period Jitter ^[1]	T _{jitt_per}	–	0.62	0.72	ps	Measured based on 10K cycle
Peak Cycle-to-cycle Jitter ^[1]	T _{jitt_cc}	–	3.5	4.4	ps	Measured based on 1K cycle

Note:

1. Measured according to JESD65B using Keysight DSAX91604A Oscilloscope.

Table 4. Electrical Characteristics – LVPECL | Supply voltage (“order code”): 2.5 V $\pm 10\%$ (“25”), 3.3 V $\pm 10\%$ (“33”), 2.25 V to 3.63 V (“XX”). All typical specifications are measured at nominal supply voltage of 2.5 V and nominal frequency of 155.52 MHz unless otherwise stated. See [Figure 4](#) and [Figure 5](#) for test setups.

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Current Consumption						
Current Consumption, Output Enabled without Termination	Idd_oe_nt	–	35.5	43	mA	Excluding load termination current.
Current Consumption, Output Enabled with Termination 1	Idd_oe_wt1	–	46	56	mA	Including load termination current as shown in Figure 26 Error! Reference source not found. for Vdd=3.3 V $\pm 10\%$, Vdd=2.25 V to 3.63 V and R3=220 Ohms.
		–	46	52.5	mA	Including load termination current as shown in Figure 26 Error! Reference source not found. for Vdd=2.5 V $\pm 10\%$ and R3=220 Ohms.
Current Consumption, Output Enabled with Termination 2	Idd_oe_wt2	–	62	67	mA	Including load termination current. See Figure 27 Error! Reference source not found. for termination.
Current Consumption Output Disabled with Termination 1	Idd_od_wt1	–	53	65	mA	Including load termination current as shown in Figure 26 Error! Reference source not found. for Vdd=3.3 V $\pm 10\%$, Vdd=2.25 V to 3.63 V and R3=220 Ohms. Driver output is at logic-high voltage levels.
		–	53	61	mA	Including load termination current as shown in Figure 26 Error! Reference source not found. for Vdd=2.5 V $\pm 10\%$ and R3=220 Ohms. Driver output is at logic-high voltage levels.
Current Consumption, Output Disabled with Termination 2	Idd_od_wt2	–	72	78.5	mA	Including load termination current. See Figure 27 Error! Reference source not found. for termination. Driver output is at logic-high voltage levels.
Output Characteristics						
Output High Voltage	VOH	Vdd-1.095	Vdd-0.95	Vdd-0.855	V	See Figure 14 for waveform.
Output Low Voltage	VOL	Vdd-1.845	Vdd-1.7	Vdd-1.61	V	See Figure 14 for waveform.
Output Differential Voltage Swing	V_Swing	1.4	1.5	1.65	V	See Figure 15 for waveform.
Rise/Fall Time	Tr, Tf	–	170	220	ps	20% to 80%. See Figure 15 for waveform.
Differential Asymmetry, peak-peak	V_da	–	45	–	mV	See Figure 17 for waveform.
Differential Skew, peak	V_ds	–	± 30	–	ps	See Figure 18 for waveform.
Overshoot Voltage, peak	V_ov	–	12	–	%	Measured as percent of V_Swing. See Figure 19 for waveform.
Power Supply Noise Immunity						
Power Supply-Induced Jitter Sensitivity	PSJS	–	9	–	fs/mV	Power supply ripple from 10 kHz to 20 MHz
		–	3.0	–	fs/mV	Power supply ripple from 10 kHz to 20 MHz. Using RC power supply filter as shown in Figure 4 .
Power Supply-Induced Phase Noise	PSPN	–	-79	–	dBc	50 mV peak-peak ripple on VDD.
		–	-89	–	dBc	50 mV peak-peak ripple on VDD. Using RC power supply filter as shown in Figure 4 .

Table 5. Electrical Characteristics – FlexSwing | Supply voltage (“order code”) referred to VDD, only: 2.5 V $\pm 10\%$ (“25”), 3.3 V $\pm 10\%$ (“33”), 2.25 V to 3.63 V (“XX”). All typical specifications are measured at nominal frequency of 155.52 MHz unless otherwise stated. See [Figure 6](#) and [Figure 7](#) for test setups.

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Current Consumption						
Current Consumption, Output Enabled without Termination	Idd_oe_nt	–	36.5	45	mA	Excluding load termination current.
Current Consumption, Output Enabled with Termination	Idd_oe_wt	–	44	55	mA	Including load termination current, for FlexSwing order code “ER”. See Figure 26 for Vdd=3.3 V ±10%, Vdd=2.25 V to 3.63 V, and R3=100 Ohms.
		–	44	51	mA	Including load termination current, for FlexSwing order code “ER”. See Figure 26 for Vdd=2.5 V ±10%, and R3=100 Ohms.
Current Consumption Output Disabled with Termination	Idd_od_wt	–	49.5	61	mA	Including load termination current, for FlexSwing order code “ER”. See Figure 26 for Vdd=3.3 V ±10%, Vdd=2.25 V to 3.63 V, and R3=100 Ohms. Driver output is at logic-high voltage levels.
		–	49.5	57	mA	Including load termination current, for FlexSwing order code “ER”. See Figure 26 for Vdd=2.5 V ±10%, and R3=100 Ohms. Driver output is at logic-high voltage levels.
Output Characteristics						
Output High Voltage	VOH	VHn -0.14	VHn	VHn +0.1	V	See Figure 14 for waveform; Refer to Table 17 or Table 18 order codes for nominal VOH (i.e. VHn) values
Output Low Voltage	VOL	VLn -0.15	VLn	VLn +0.12	V	See Figure 14 for waveform; Refer to Table 17 or Table 18 order codes for nominal VOH (i.e. VHn) values
Output Differential Voltage Swing	V_Swing	-15%	2*(VHn-VLn)	+15%	V	See Figure 15 for waveform.
Rise/Fall Time	Tr, Tf	–	170	200	ps	20% to 80%. See Figure 15 for waveform.
Differential Asymmetry, peak-peak	V_da	–	55	–	mV	See Figure 17 for waveform.
Differential Skew, peak	V_ds	–	±40	–	ps	See Figure 18 for waveform.
Overshoot Voltage, peak	V_ov	–	12	–	%	Measured as percent of V_Swing. See Figure 19 for waveform.
Power Supply Noise Immunity						
Power Supply-Induced Jitter Sensitivity	PSJS	–	14	–	fs/mV	Power supply ripple from 10 kHz to 20 MHz. For FlexSwing order code “ER”.
		–	2	–	fs/mV	Power supply ripple from 10 kHz to 20 MHz. For FlexSwing order code “ER”. Using RC power supply filter as shown in Figure 6 .
Power Supply-Induced Phase Noise	PSPN	–	-75	–	dBc	50 mV peak-peak ripple on VDD. For FlexSwing order code “ER”.
		–	-93	–	dBc	50 mV peak-peak ripple on VDD. For FlexSwing order code “ER”. Using RC power supply filter as shown in Figure 6 .

Table 6. Electrical Characteristics – FlexSwing | Supply voltage (“order code”) referred to GND, only: 1.8 V $\pm 5\%$ (“18”), 1.71 V to 3.63 V (“YY”). All typical specifications are measured at nominal frequency of 155.52 MHz unless otherwise stated. See [Figure 6](#) and [Figure 7](#) for test setups.

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Current Consumption						
Current Consumption, Output Enabled without Termination	Idd_oe_nt	–	38	45	mA	Excluding load termination current.
Current Consumption, Output Enabled with Termination	Idd_oe_wt	–	45.5	51	mA	Including load termination current, for FlexSwing order code “3E”. See Figure 26 for Vdd=1.8 V ±5% and R3=1-0 Ohms.
		–	45.5	53	mA	Including load termination current, for FlexSwing order code “3E”. See Figure 26 for Vdd=1.71 V to 3.63 V and R3=100 Ohms.
Current Consumption Output Disabled with Termination	Idd_od_wt	–	51.5	57.5	mA	Including load termination current, for FlexSwing order code “3E”. See Figure 26 for Vdd=1.8 V ±5% and R3=100 Ohms. Driver output is at logic-high voltage levels.
		–	51.5	59	mA	Including load termination current, for FlexSwing order code “3E”. See Figure 26 for Vdd=1.71 V to 3.63 V and R3=100 Ohms. Driver output is at logic-high voltage levels.
Output Characteristics						
Output High Voltage	VOH	VHn – 0.1	VHn	VHn + 0.12	V	See Figure 14 for waveform; Refer to Table 17 or Table 18 order codes for nominal VOH (i.e. VHn) values
Output Low Voltage	VOL	VLn – 0.1	VLn	VLn + 0.12	V	See Figure 14 for waveform; Refer to Table 17 or Table 18 order codes for nominal VOH (i.e. VHn) values
Output Differential Voltage Swing	V_Swing	-15%	2*(VHn-VLn)	+15%	V	See Figure 15 for waveform.
Rise/Fall Time	Tr, Tf	–	170	215	ps	20% to 80%. See Figure 15 for waveform.
Differential Asymmetry, peak-peak	V_da	–	60	–	mV	See Figure 17 for waveform.
Differential Skew, peak	V_ds	–	±40	–	ps	See Figure 18 for waveform.
Overshoot Voltage, peak	V_ov	–	12	–	%	Measured as percent of V_Swing. See Figure 19 for waveform.
Power Supply Noise Immunity						
Power Supply-Induced Jitter Sensitivity	PSJS	–	12.5	–	fs/mV	Power supply ripple from 10 kHz to 20 MHz. For FlexSwing order code “3E”.
		–	2	–	fs/mV	Power supply ripple from 10 kHz to 20 MHz. For FlexSwing order code “3E”. Using RC power supply filter as shown in Figure 6 .
Power Supply-Induced Phase Noise	PSPN	–	-76	–	dBc	50 mV peak-peak ripple on VDD. For FlexSwing order code “3E”.
		–	-94	–	dBc	50 mV peak-peak ripple on VDD. For FlexSwing order code “3E”. Using RC power supply filter as shown in Figure 6 .

Table 7. Electrical Characteristics – FlexSwing | Supply voltage (“order code”) referred to GND, only: 2.5 V \pm 10% (“25”), 3.3 V \pm 10% (“33”), 2.25 V to 3.63 V (“XX”). All typical specifications are measured at nominal frequency of 155.52 MHz unless otherwise stated. See [Figure 6](#) and [Figure 7](#) for test setups.

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Current Consumption						
Current Consumption, Output Enabled without Termination	Idd_oe_nt	–	37	43	mA	Excluding load termination current.
Current Consumption, Output Enabled with Termination	Idd_oe_wt	–	44.5	51	mA	Including load termination current, for FlexSwing order code “VP”. See Figure 26 for Vdd=3.3 V \pm 10%, Vdd=2.25 V to 3.63 V, and R3=100 Ohms.
Current Consumption Output Disabled with Termination	Idd_od_wt	–	53	60.5	mA	Including load termination current, for FlexSwing order code “VP”. See Figure 26 for Vdd=3.3 V \pm 10%, Vdd=2.25 V to 3.63 V, and R3=100 Ohms. Driver output is at logic-high voltage levels.
Output Characteristics						
Output High Voltage	VOH	VHn - 0.115	VHn	VHn + 0.1	V	See Figure 14 for waveform; Refer to Table 17 or Table 18 order codes for nominal VOH (i.e. VHn) values
Output Low Voltage	VOL	VLn - 0.1	VLn	VLn + 0.1	V	See Figure 14 for waveform; Refer to Table 17 or Table 18 order codes for nominal VOH (i.e. VHn) values
Output Differential Voltage Swing	V_Swing	-15%	2*(VHn-VLn)	+15%	V	See Figure 15 for waveform.
Rise/Fall Time	Tr, Tf	–	170	210	ps	20% to 80%. See Figure 15 for waveform.
Differential Asymmetry, peak-peak	V_da	–	60	–	mV	See Figure 17 for waveform.
Differential Skew, peak	V_ds	–	\pm 40	–	ps	See Figure 18 for waveform.
Overshoot Voltage, peak	V_ov	–	12	–	%	Measured as percent of V_Swing. See Figure 19 for waveform.
Power Supply Noise Immunity						
Power Supply-Induced Jitter Sensitivity	PSJS	–	14	–	fs/mV	Power supply ripple from 10 kHz to 20 MHz. For FlexSwing order code “VP”.
		–	2	–	fs/mV	Power supply ripple from 10 kHz to 20 MHz. For FlexSwing order code “VP”. Using RC power supply filter as shown in Figure 6 .
Power Supply-Induced Phase Noise	PSPN	–	-75	–	dBc	50 mV peak-peak ripple on VDD. For FlexSwing order code “VP”.
		–	-94	–	dBc	50 mV peak-peak ripple on VDD. For FlexSwing order code “VP”. Using RC power supply filter as shown in Figure 6 .

Table 8. Electrical Characteristics – LVDS | Supply voltage (“order code”): 2.5 V $\pm 10\%$ (“25”), 3.3 V $\pm 10\%$ (“33”), 2.25 V to 3.63 V (“XX”). All typical specifications are measured at nominal supply of 2.5 V and nominal frequency of 155.52 MHz unless otherwise stated. See [Figure 8](#) and [Figure 9](#) for test setups.

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Current Consumption						
Current Consumption, Output Enabled without Termination	Idd_oe_nt	–	32.5	38	mA	Excluding load termination current.
Current Consumption, Output Enabled with Termination	Idd_oe_wt	–	36	42	mA	Including load termination current. See Figure 29 for termination.
Current Consumption Output Disabled with Termination	Idd_od_wt	–	42	48	mA	Including load termination current. See Figure 29 for termination. Driver output is at logic-high voltage levels.
Output Characteristics						
Differential Output Voltage	VOD	250	370	450	mV	See Figure 16 for waveform.
Delta VOD	ΔVOD	–	–	50	mV	See Figure 16 for waveform.
Offset Voltage	VOS	1.125	1.25	1.375	V	See Figure 16 for waveform.
Delta VOS	ΔVOS	–	–	50	mV	See Figure 16 for waveform.
Rise/Fall Time	Tr, Tf	–	290	340	ps	Measured 20% to 80% using Figure 29 for termination. See Figure 15 for waveform.
Differential Asymmetry, peak-peak	V_da	–	25	–	mV	See Figure 17 for waveform.
Differential Skew, peak	V_ds	–	± 40	–	ps	See Figure 18 for waveform.
Overshoot Voltage, peak	V_ov	–	8	–	%	Measured as percent of VOD. See Figure 20 for waveform.
Power Supply Noise Immunity						
Power Supply-Induced Jitter Sensitivity	PSJS	–	17	–	fs/mV	Power supply ripple from 10 kHz to 20 MHz
		–	4.0	–	fs/mV	Power supply ripple from 10 kHz to 20 MHz Using RC power supply filter as shown in Figure 8 .
Power Supply-Induced Phase Noise	PSPN	–	-74	–	dBc	50 mV peak-peak ripple on VDD.
		–	-86.5	–	dBc	50 mV peak-peak ripple on VDD. Using RC power supply filter as shown in Figure 8 .

Table 9. Electrical Characteristics – LVDS | Supply voltage (“order code”): 1.8 V \pm 5% (“18”), 1.71 V to 3.63 V (“YY”). All typical specifications are measured at nominal supply of 2.5 V and nominal frequency of 155.52 MHz unless otherwise stated. See [Figure 8](#) and [Figure 9](#) for test setups.

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Current Consumption						
Current Consumption, Output Enabled without Termination	Idd_oe_nt	–	32.5	38	mA	Excluding load termination current.
Current Consumption, Output Enabled with Termination	Idd_oe_wt	–	36	42	mA	Including load termination current. See Figure 29 for termination.
Current Consumption Output Disabled with Termination	Idd_od_wt	–	42	48	mA	Including load termination current. See Figure 29 for termination. Driver output is at logic-high voltage levels.
Output Characteristics						
Differential Output Voltage	VOD	250	350	450	mV	See Figure 16 for waveform.
Delta VOD	Δ VOD	–	–	50	mV	See Figure 16 for waveform.
Offset Voltage	VOS	1.125	1.25	1.375	V	See Figure 16 for waveform.
Delta VOS	Δ VOS	–	–	50	mV	See Figure 16 for waveform.
Rise/Fall Time	Tr, Tf	–	290	340	ps	Measured 20% to 80% using Figure 29 for termination. See Figure 15 for waveform.
Differential Asymmetry, peak-peak	V_da	–	25	–	mV	See Figure 17 for waveform.
Differential Skew, peak	V_ds	–	\pm 40	–	ps	See Figure 18 for waveform.
Overshoot Voltage, peak	V_ov	–	8	–	%	Measured as percent of VOD. See Figure 20 for waveform.
Power Supply Noise Immunity						
Power Supply-Induced Jitter Sensitivity	PSJS	–	19.5	–	fs/mV	Power supply ripple from 10 kHz to 20 MHz
		–	4.0	–	fs/mV	Power supply ripple from 10 kHz to 20 MHz. Using RC power supply filter as shown in Figure 8 .
Power Supply-Induced Phase Noise	PSPN	–	-72.5	–	dBc	50 mV peak-peak ripple on VDD.
		–	-86.5	–	dBc	50 mV peak-peak ripple on VDD. Using RC power supply filter as shown in Figure 8 .

Table 10. Electrical Characteristics – HCSL | Supply voltage (“order code”): 2.5 V $\pm 10\%$ (“25”), 3.3 V $\pm 10\%$ (“33”), 2.25 V to 3.63 V (“XX”), 1.8 V $\pm 5\%$ (“18”), 1.71 V to 3.63 V (“YY”). All typical specifications are measured at nominal supply of 2.5 V and nominal frequency of 155.52 MHz unless otherwise stated. See [Figure 10](#) and [Figure 11](#) for test setups.

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Current Consumption						
Current Consumption, Output Enabled without Termination	Idd_oe_nt	–	32	38.5	mA	Excluding load termination current.
Current Consumption, Output Enabled with Termination	Idd_oe_wt	–	46.5	53	mA	Including load termination current. See Figure 30 (a) and Figure 30 (b) for termination.
Current Consumption, Output Disabled with Termination	Idd_od_wt	–	52.5	59.5	mA	Including load termination current. See Figure 30 (a) and Figure 30 (b) for termination. Driver output is at logic-high voltage levels.
Output Characteristics						
Output High Voltage	VOH	0.60	0.7	0.95	V	See Figure 14 for waveform.
Output Low Voltage	VOL	-0.1	0	0.1	V	See Figure 14 for waveform.
Output Differential Voltage Swing	V_Swing	1.1	1.4	1.6	V	See Figure 15 for waveform.
Rise/Fall Time	Tr, Tf	–	340	385	ps	Measured 20% to 80%. See Figure 15 for waveform.
Differential Asymmetry, peak-peak	V_da	–	65	–	mV	See Figure 17 for waveform.
Differential Skew, peak	V_ds	–	± 70	–	ps	See Figure 18 for waveform.
Overshoot Voltage, peak	V_ov	–	0	–	%	Measured as percent of V_Swing. See Figure 19 for waveform.
Power Supply Noise Immunity						
Power Supply-Induced Jitter Sensitivity	PSJS	–	28	–	fs/mV	Power supply ripple from 10 kHz to 20 MHz
		–	3.5	–	fs/mV	Power supply ripple from 10 kHz to 20 MHz. Using RC power supply filter as shown in Figure 10 .
Power Supply-Induced Phase Noise	PSPN	–	-69	–	dBc	50 mV peak-peak ripple on VDD
		–	-87	–	dBc	50 mV peak-peak ripple on VDD. Using RC power supply filter as shown in Figure 10 .

Table 11. Electrical Characteristics – Low-Power HCSL | Supply voltage (“order code”): 2.5 V $\pm 10\%$ (“25”), 3.3 V $\pm 10\%$ (“33”), 2.25 V to 3.63 V (“XX”), 1.8 V $\pm 5\%$ (“18”), 1.71 V to 3.63 V (“YY”). All typical specifications are measured at nominal supply of 2.5 V and nominal frequency of 155.52 MHz unless otherwise stated. See [Figure 12](#) and [Figure 13](#) for test setups.

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Current Consumption						
Current Consumption, Output Enabled without Termination	Idd_oe_nt	–	33	39	mA	Excluding load termination current.
Current Consumption, Output Enabled with Termination	Idd_oe_wt	–	33.5	40	mA	Including load termination current. See Figure 31 for termination.
Current Consumption, Output Disabled with Termination	Idd_od_wt	–	35.5	42	mA	Including load termination current. See Figure 31 for termination. Driver output is at logic-high voltage levels.
Output Characteristics						
Output High Voltage	VOH	0.8	0.9	1.15	V	See Figure 14 for waveform.
Output Low Voltage	VOL	-0.1	0	0.1	V	See Figure 14 for waveform.
Output Differential Voltage Swing	V_Swing	1.6	1.83	2.0	V	See Figure 15 for waveform.
Rise/Fall Time	Tr, Tf	–	330	365	ps	Measured 20% to 80%. See Figure 15 for waveform.
Differential Asymmetry, peak-peak	V_da	–	55	–	mV	See Figure 17 for waveform.
Differential Skew, peak	V_ds	–	± 30	–	ps	See Figure 18 for waveform.
Overshoot Voltage, peak	V_ov	–	1	–	%	Measured as percent of V_Swing. See Figure 19 for waveform.
Power Supply Noise Immunity						
Power Supply-Induced Jitter Sensitivity	PSJS	–	17	–	fs/mV	Power supply ripple from 10 kHz to 20 MHz
		–	6.5	–	fs/mV	Power supply ripple from 10 kHz to 20 MHz. Using RC power supply filter as shown in Figure 12 .
Power Supply-Induced Phase Noise	PSPN	–	-73	–	dBc	50 mV peak-peak ripple on VDD.
		–	-82	–	dBc	50 mV peak-peak ripple on VDD. Using RC power supply filter as shown in Figure 12 .

Table 12. Absolute Maximum Ratings

Operation outside the absolute maximum ratings may cause permanent damage to the part.
Performance of the IC is only guaranteed within the operational specifications, not at absolute maximum ratings.

Parameter	Test Conditions	Min.	Max.	Unit
Continuous Power Supply Voltage Range (Vdd)		-0.5	4.0	V
Input Voltage, Maximum	Any input pin	–	Vdd + 0.3	V
Input Voltage, Minimum	Any input pin	-0.3	–	V
Storage Temperature		-65	150	°C
Maximum Junction Temperature		–	150	°C

Table 13. Thermal Considerations^[2]

Package	θ_{JA} (°C/W)	Ψ_{JT} (°C/W)	θ_{JB} (°C/W)	$\theta_{JC,Top}$ (°C/W)
3225, 6-pin	101	4.7	23	86
2520, 6-pin	111	3.7	24	116
2016, 6-pin	134	3.4	24	147

Notes:

- θ_{JA} , Ψ_{JT} , θ_{JB} and θ_{JC} are provided according to JEDEC standards 51-2A, 51-7, 51-8, and 51-12.01 with a 25°C ambient and 250 mW power consumption (typical of 1 GHz f_{out}). The conduction thermal resistances θ_{JB} and θ_{JC} are obtained with the assumption that all heat flows from the junction to a heat sink through either the solder pads (θ_{JB}) or the top of the package ($\theta_{JC,Top}$). These may be used in a two-resistor compact model. The values of θ_{JA} and Ψ_{JT} are strongly application dependent, and we report values based on the JEDEC thermal environment. θ_{JA} is the thermal resistance to ambient on a JEDEC PCB - it is a highly conservative estimate, since the JEDEC board does not have vias to PCB planes in the vicinity of the package. Ψ_{JT} can be used to estimate the junction temperature from measurements of the temperature at the top of the package if the thermal environment is similar to the JEDEC environment.

Table 14. Maximum Operating Junction Temperature^[3]

Max Operating Temperature (ambient)	Maximum Operating Junction Temperature
85°C	100°C
105°C	120°C
125°C	145°C

Notes:

- Datasheet specifications are not guaranteed if junction temperature exceeds the maximum operating junction temperature.

Table 15. Environmental Compliance

Parameter	Test Conditions	Value	Unit
Mechanical Shock Resistance	MIL-STD-883F, Method 2002	30,000	<i>g</i>
Mechanical Vibration Resistance	MIL-STD-883F, Method 2007	70	<i>g</i>
Altitude	MIL-STD-202, Method 105, Condition C	70,000	ft
Soldering Temperature (follow standard Pb free soldering guidelines) ^[4]	MIL-STD-883F, Method 2003	260	°C
Moisture Sensitivity Level	MSL1 @ 260°C		
Electrostatic Discharge (HBM)	HBM, JESD22-A114	2,000	V
Charge-Device Model ESD Protection	JESD220C101	750	V
Latch-up Tolerance	JESD78 Compliant		

Notes:

- Please refer to [SiTime Manufacturing Notes](#).

Pin Description

Table 16. Pin Description

Pin	Map	Functionality	
1	OE/NF	Output Enable (OE)	H ^[5] : Specified frequency output L ^[6] : OUT: Logic HIGH,
		No Function (NF)	Open, 120 kΩ internal pull-down resistor to GND
2	NF	No Function	H or L or Open: No effect on output frequency or other device functions. ^[7]
3	GND	Power	Power Supply Ground
4	OUTP	Output	Oscillator output
5	OUTN	Output	Complementary oscillator output
6	VDD	Power	Power supply voltage ^[8]

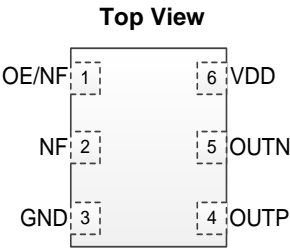


Figure 3. Pin Assignments

- Notes:
- 5. OE pin includes a 120 kΩ internal pull-up resistor to VDD when active high, and a 120 kΩ internal pull-down resistor to GND when active low. In noisy environments, the OE pin is recommended to include an external 10 kΩ resistor (Use 10kΩ pull-up if active high OE; use 10kΩ pull-down if active low OE) when the pin is not externally driven.
 - 6. Differential Logic high means OUTP=VOH, OUTN=VOL.
 - 7. Can be left open. SiTime recommends grounding it for better thermal performance.
 - 8. A capacitor of value 0.1 μF or higher between VDD and GND pins is required.

Table 18. FlexSwing 2-digit Order Codes specifying VHn and VLn referenced to voltage on GND pin

[illegible]

Note:

10. Please [contact SiTime](#).

Test Circuit Diagrams

A 1.5 pF capacitive load is used at each differential output. Because of the additive input capacitance of the active probe used with the oscilloscope, the output characteristics for all signal types are measured with a total of 2 pF capacitive load.

Test Setups for LVPECL Measurements

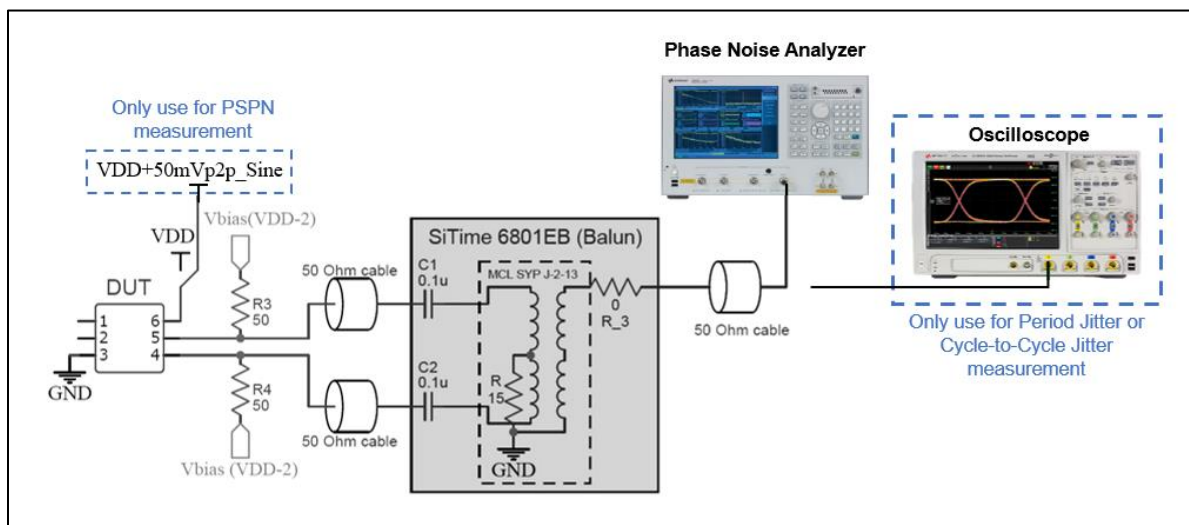


Figure 4. Test setup to measure LVPECL Phase Noise, Period Jitter, Cycle-to-Cycle Jitter, and Power Supply-Induced Phase Noise (PSPN) without filter added^[11]

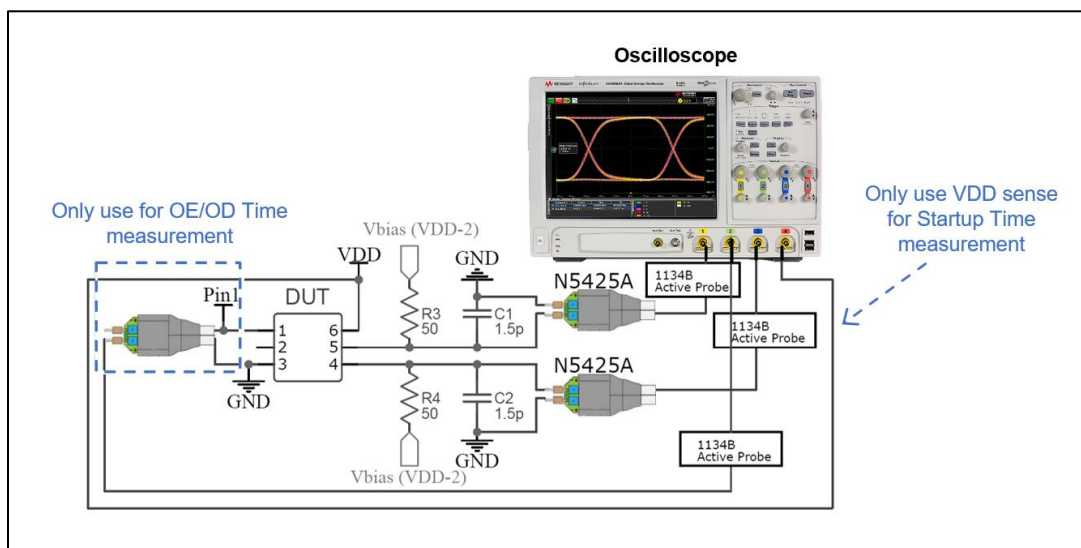


Figure 5. Test setup to measure LVPECL Output Waveform Characteristics, Current Consumption (with Termination 2)^[12], Output Enable/Disable Time, and Startup Time

Notes:

11. See Figure 6 for the test setup to measure LVPECL Power Supply-Induced Phase Noise (PSPN) with filter added.
12. See Figure 7 for the test setup to measure LVPECL Current Consumption with Termination 1 or without Termination.

Test Circuit Diagrams (continued)

Test Setups for LVDS Measurements

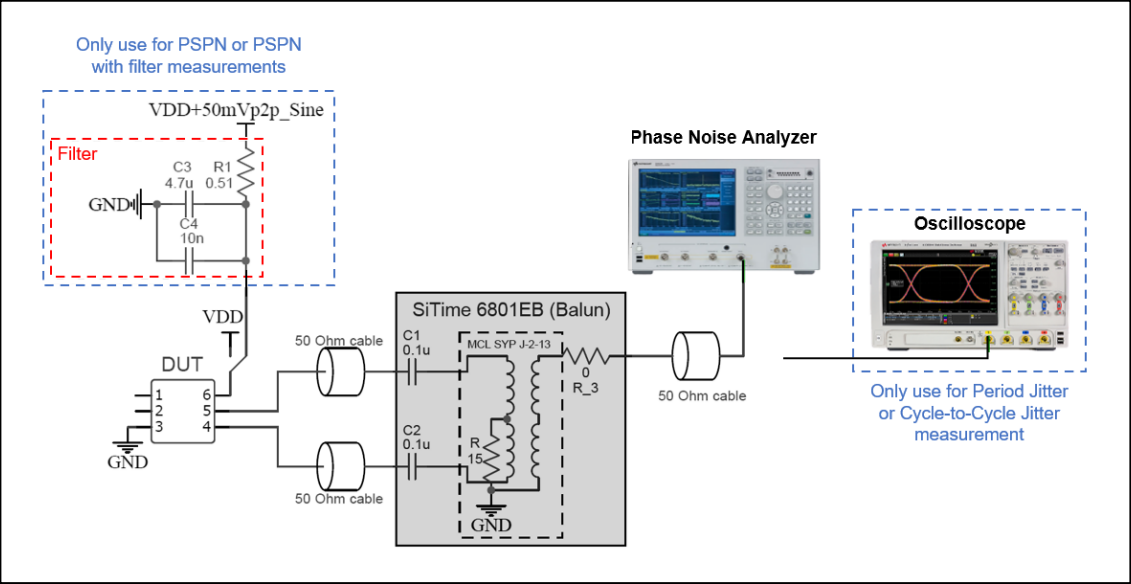


Figure 8. Test setup to measure LVDS Phase Noise, Period Jitter, Cycle-to-Cycle Jitter, and Power Supply-Induced Phase Noise (PSPN) with and without filter added

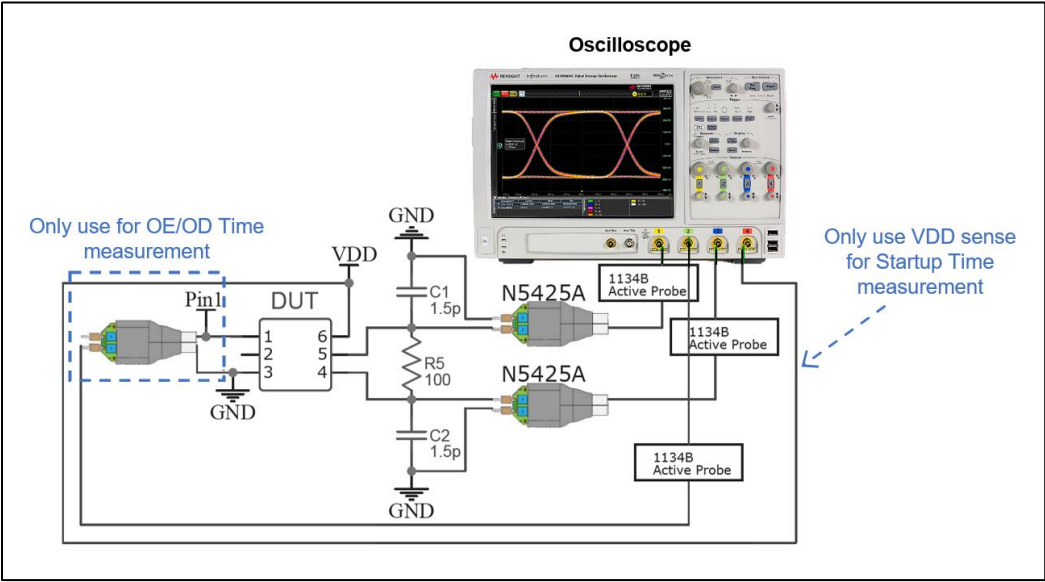


Figure 9. Test setup to measure LVDS Output Waveform Characteristics, Current Consumption, Output Enable/Disable Time, and Startup Time

Test Circuit Diagrams (continued)

Test Setups for Low-Power HCSL Measurements

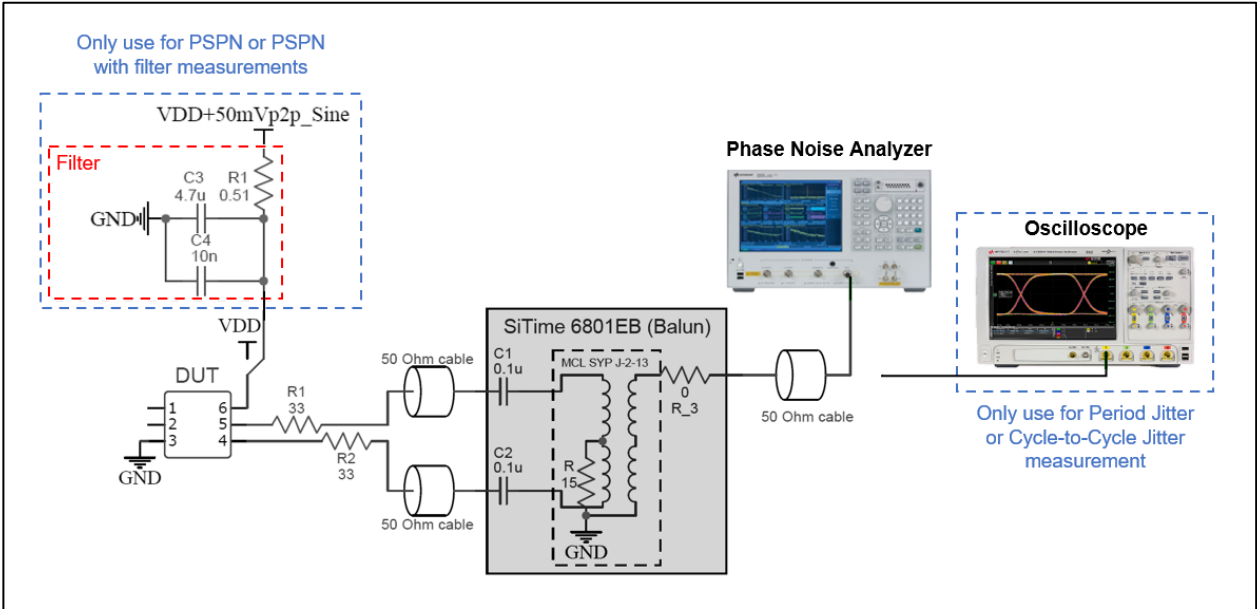


Figure 12. Test setup to measure Low-Power HCSL Phase Noise, Period Jitter, Cycle-to-Cycle Jitter, and Power Supply-Induced Phase Noise (PSPN) with and without filter added

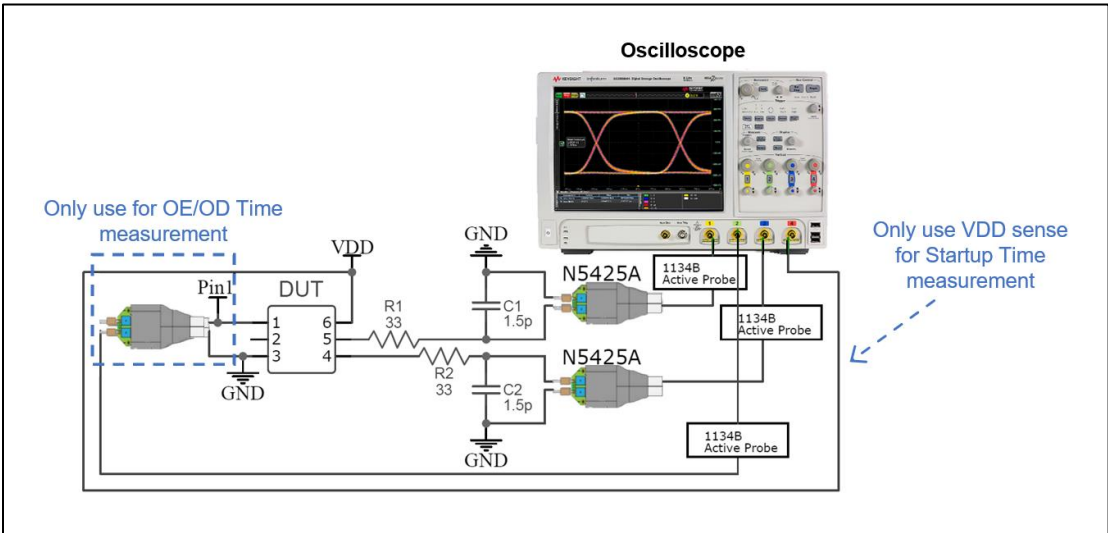


Figure 13. Test setup to measure Low-Power HCSL Output Waveform Characteristics, Current Consumption, Output Enable/Disable Time, and Startup Time

Waveform Diagrams

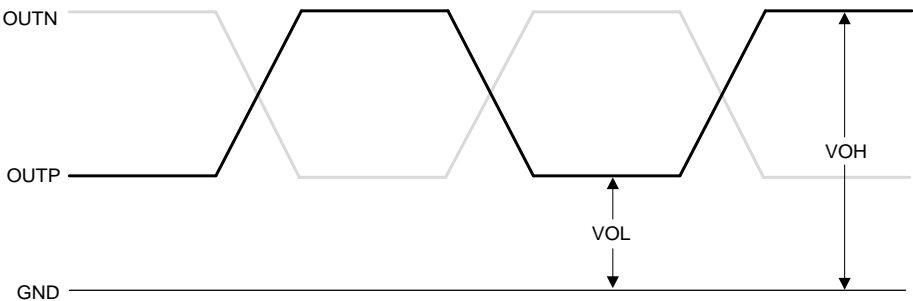


Figure 14. LVPECL, HCSL, Low-Power HCSL, and FlexSwing Voltage Levels per Differential Pin

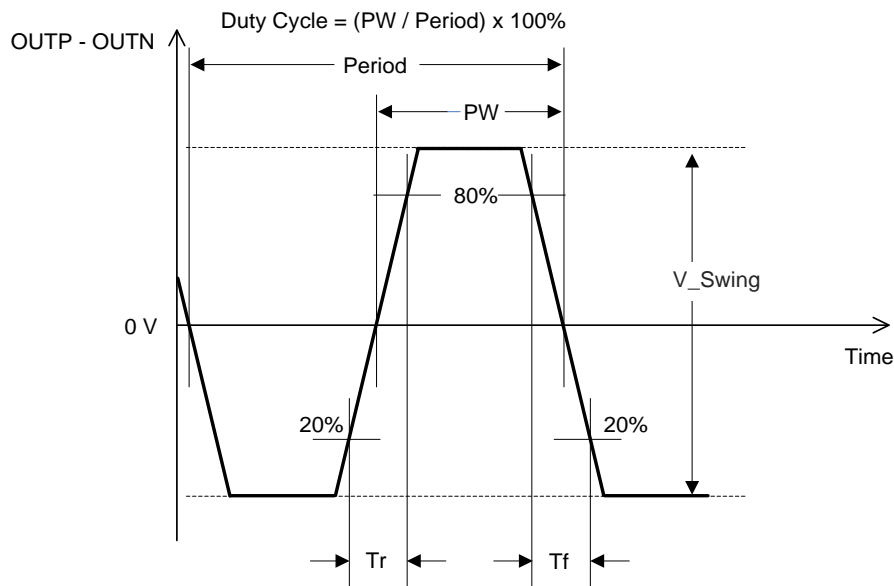


Figure 15. LVPECL, LVDS, HCSL, Low-Power HCSL, and FlexSwing Voltage Levels Across Differential Pair

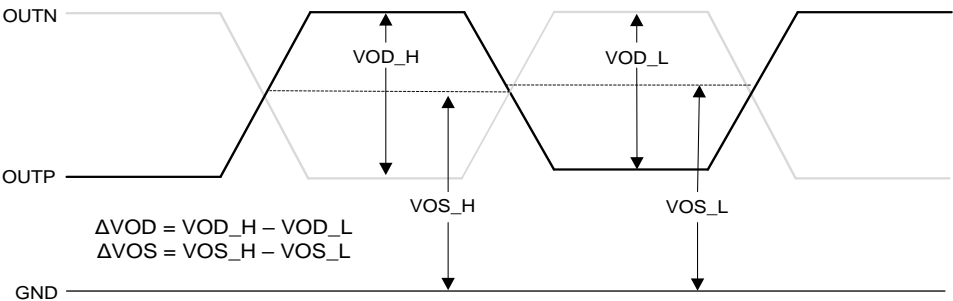


Figure 16. LVDS Voltage Levels per Differential Pin

Waveform Diagrams (continued)

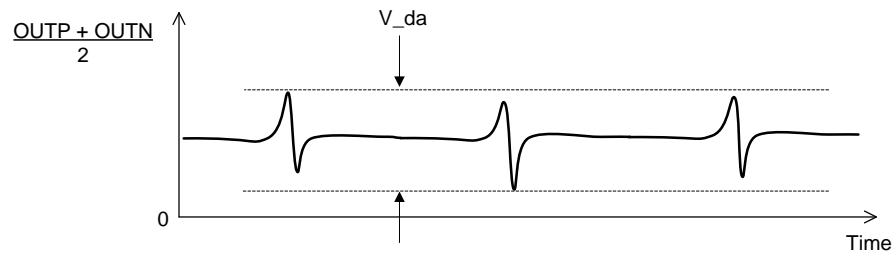


Figure 17. Differential Asymmetry (V_{da})

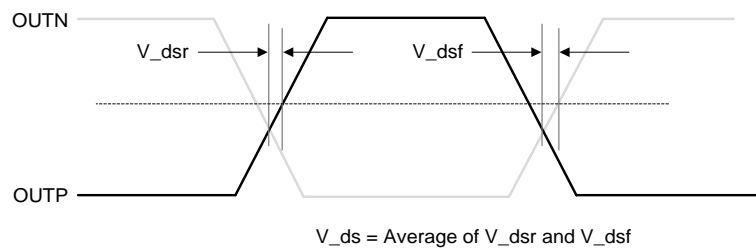


Figure 18. Differential Skew (V_{ds}) is measured as the Time between the Average Voltage Level and Crossing Voltage

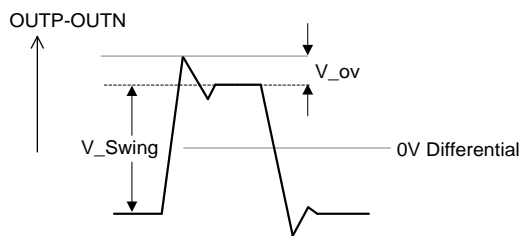


Figure 19. Overshoot Voltage (V_{ov}) for LVPECL, FlexSwing, HCSL, Low-power HCSL

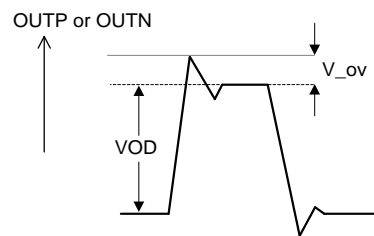


Figure 20. Overshoot Voltage (V_{ov}) for LVDS Output

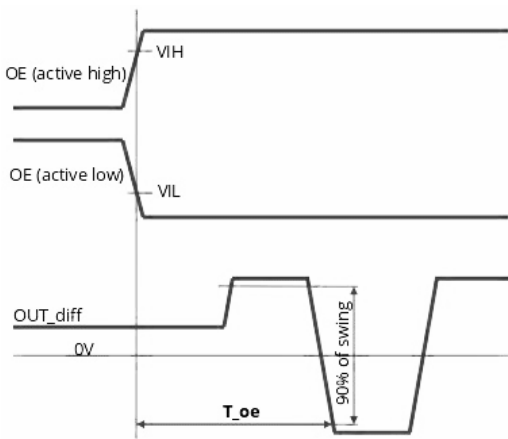


Figure 21. OE Pin Enable Timing (T_{oe})

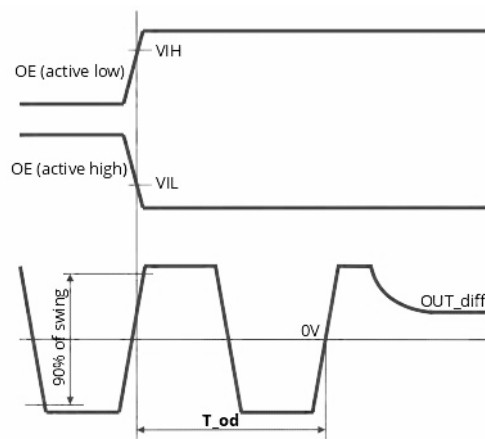


Figure 22. OE Pin Disable Timing (T_{od})

Termination Diagrams

LVPECL and FlexSwing Termination

The SiT9356 FlexSwing output drivers support low power without sacrificing signal integrity via simple terminations as shown in [Error! Reference source not found. Figure 24](#) and [Figure 26](#)[Error! Reference source not found.](#), compared to traditional LVPECL drivers. The FlexSwing and

LVPECL outputs are voltage-mode drivers. Use the table and figures below to select a termination circuit for the desired supply voltage. The table also provides LVPECL current consumption (I_{load}) into the load termination.

Table 19. Termination Options for LVPECL and FlexSwing Signaling

Signaling	Supply Voltage Order Codes	Termination Options					
		Figure 23	Figure 24	Figure 25	Figure 26	Figure 27	Figure 28
LVPECL referenced to Vdd	"25", "33", "XX"	OK to use $I_{load} = 40\text{ mA}$ with $100\text{ }\Omega$ near-end bias resistor	Do Not Use	OK to use $I_{load} = 28\text{ mA}$	OK to use	OK to use $I_{load} = 28\text{ mA}$	Do Not Use
FlexSwing referenced to Vdd			OK to use (See Error! Reference source not found. Figure 24 for frequency ranges and voltage swings)	OK to use ^[17]	OK to use	OK to use	Do Not Use
FlexSwing referenced to Gnd	"25", "33", "XX", "YY"	OK to use ^[16]		Do Not Use	OK to use	Do Not Use	Do Not Use
	"18"			Do Not Use	OK to use	Do Not Use	OK to use

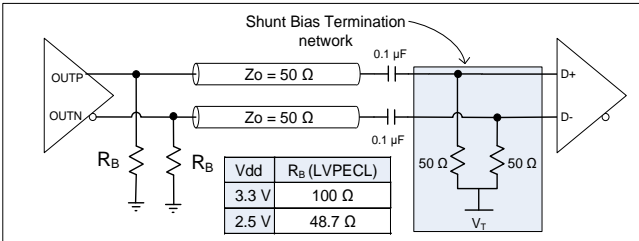


Figure 23. Recommended LVPECL and FlexSwing^[16] Termination when AC-coupled

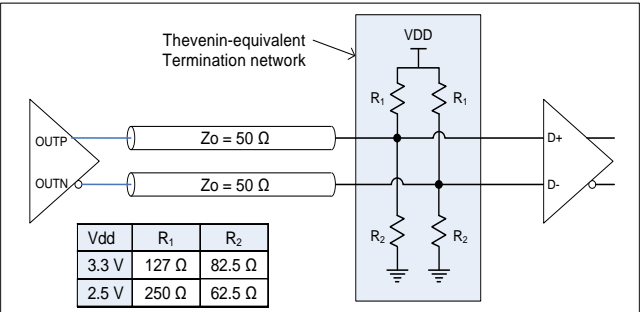


Figure 25. LVPECL and FlexSwing DC-coupled Load Termination with Thevenin Equivalent Network^[17]

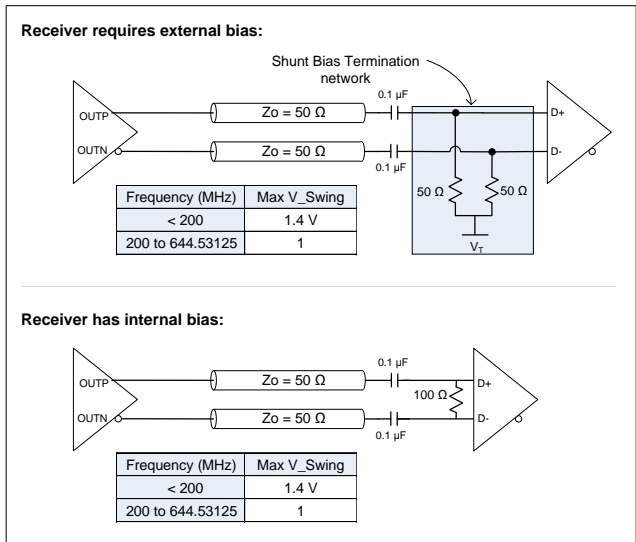


Figure 24. Recommended FlexSwing Termination when AC-coupled

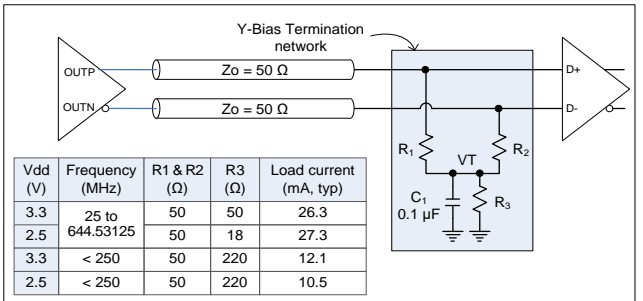


Figure 26. LVPECL and FlexSwing with DC-coupled Parallel Shunt Load Termination

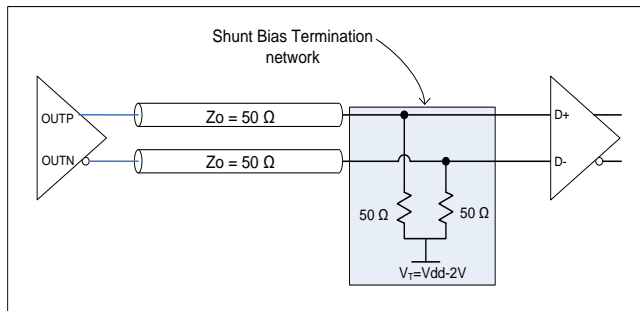


Figure 27. LVPECL and FlexSwing with Y-Bias Termination

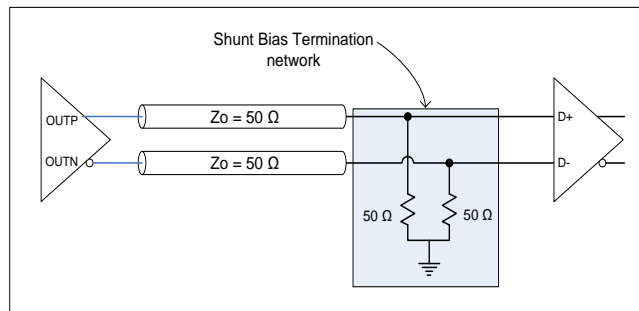


Figure 28. FlexSwing Termination – Only for use with Supply Voltage Order Code “18”

LVDS, Supply Voltage: 1.8 V \pm 5%, 2.5 V \pm 10%, 3.3 V \pm 10%, 2.25 V to 3.63 V, 1.71 V to 3.63 V

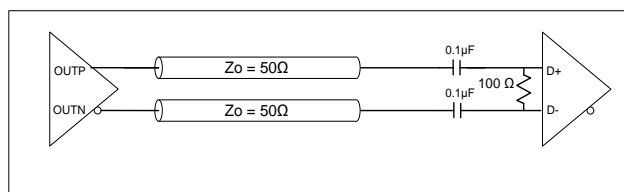


Figure 28. LVDS AC Termination

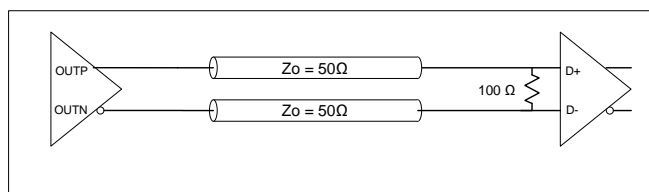


Figure 29. LVDS DC Termination at the Load

HCSL, Supply Voltage: 1.8 V \pm 5%, 2.5 V \pm 10%, 3.3 V \pm 10%, 2.25 V to 3.63 V, 1.71 V to 3.63 V

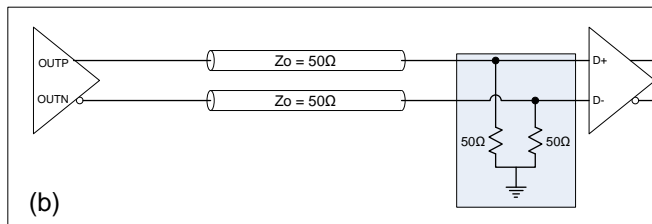
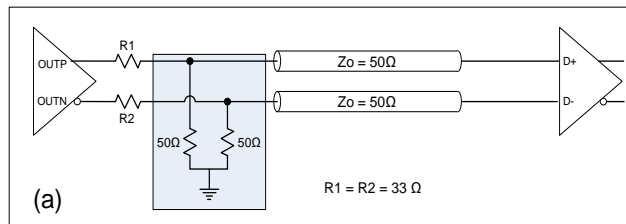


Figure 30. (a) HCSL Source Termination and (b) HCSL Load Termination

Low-power HCSL, Supply Voltage: 1.8 V \pm 5%, 2.5 V \pm 10%, 3.3 V \pm 10%, 2.25 V to 3.63 V, 1.71 V to 3.63 V

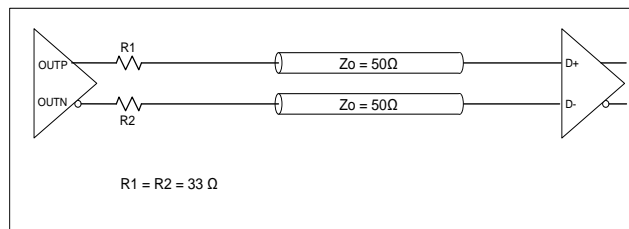
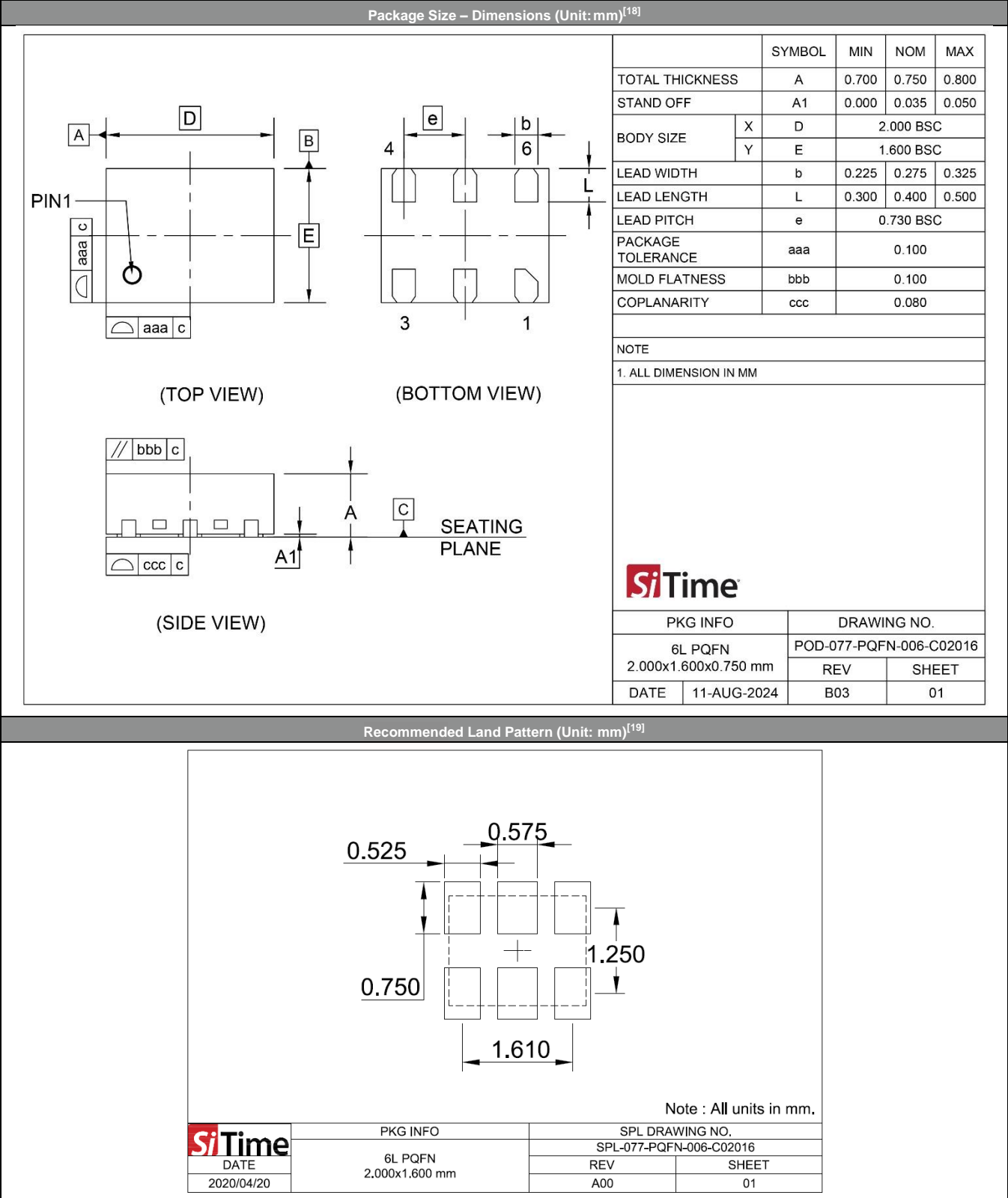


Figure 31. Low-power HCSL Termination

Notes:

16. [Contact SiTime](#) for optimum R_B values for FlexSwing options.
17. [Contact SiTime](#) for optimum R_1 and R_2 values for FlexSwing options.

Dimensions and Patterns — 2.0 x 1.6 mm x mm

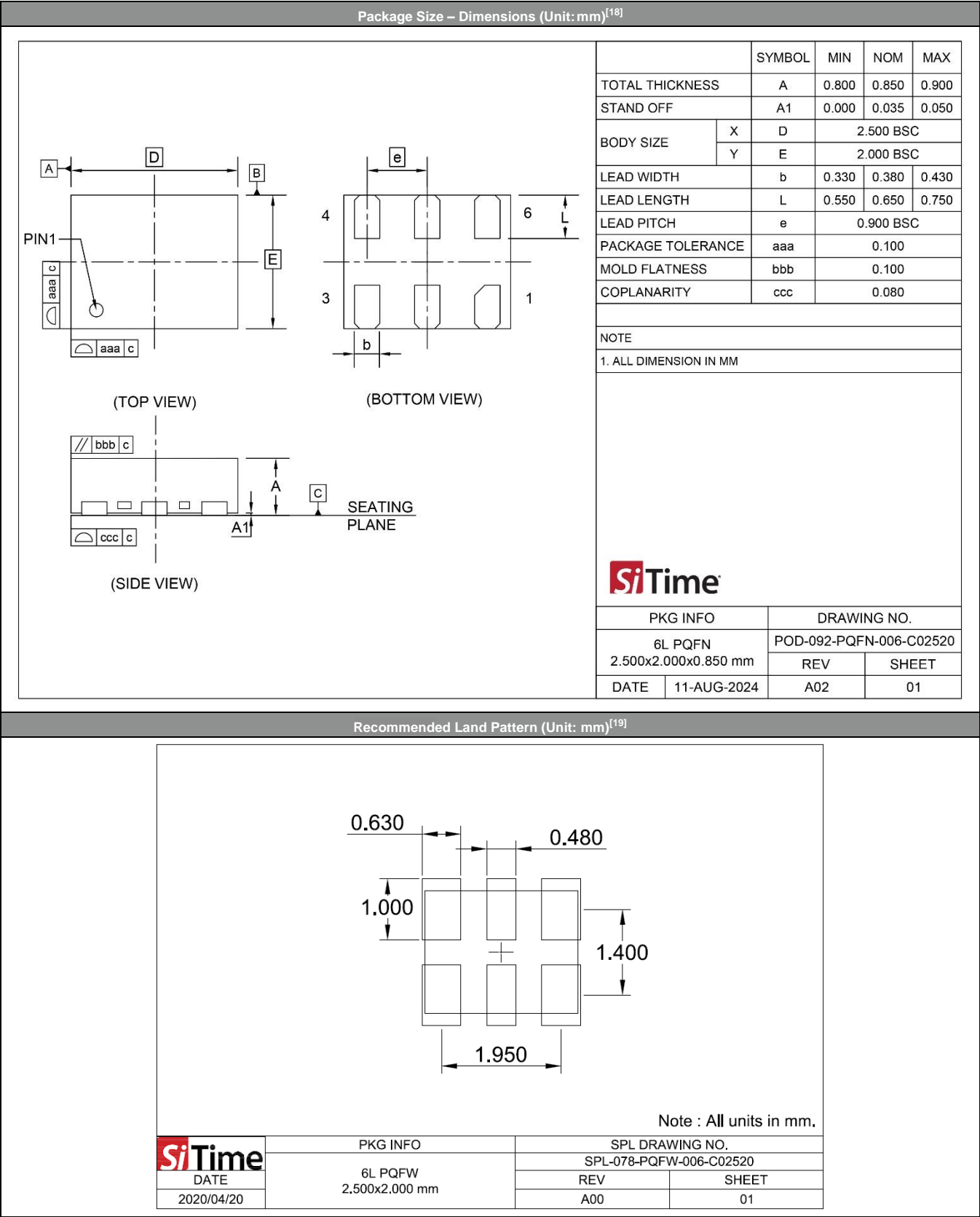


Notes:

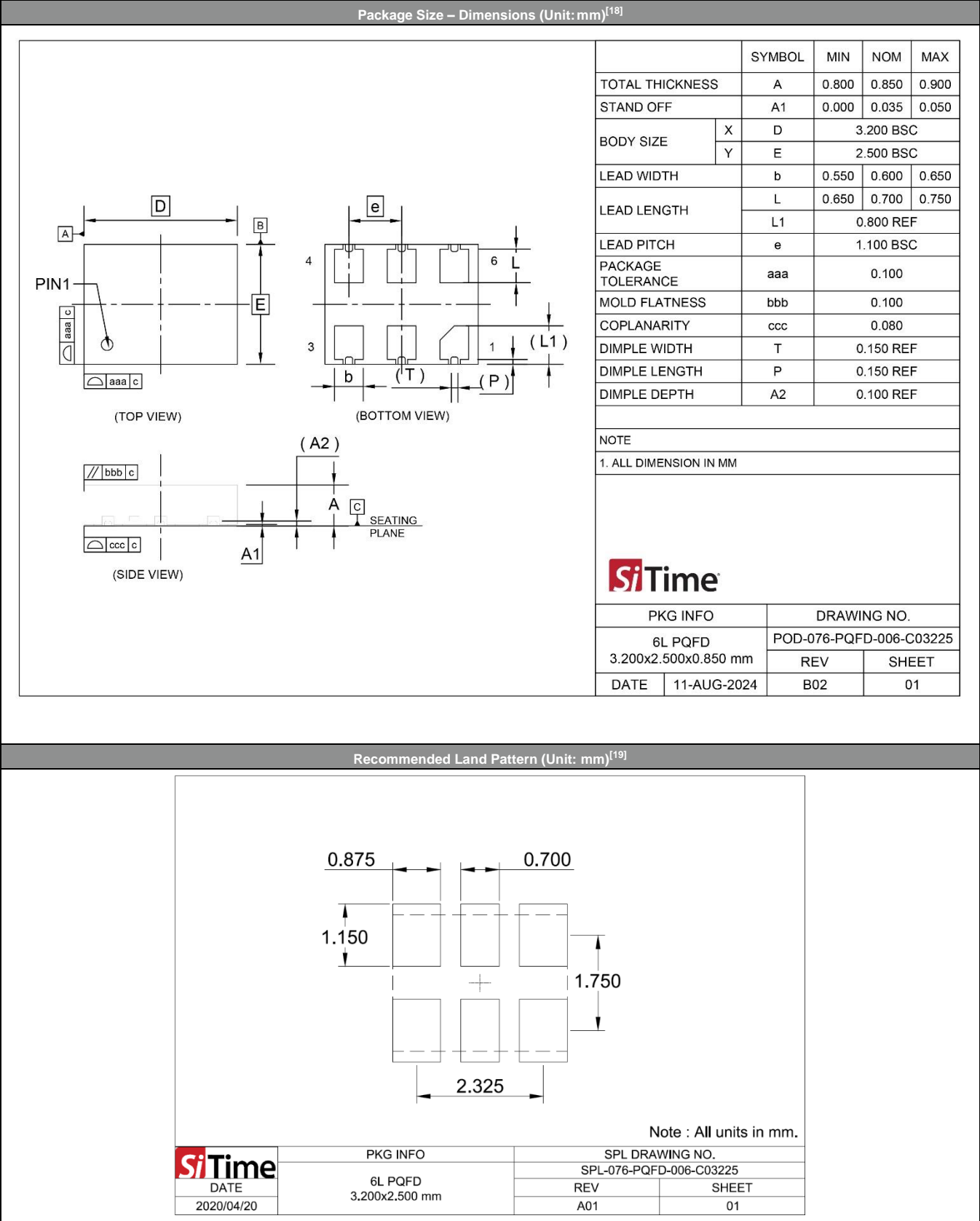
18. Top Marking: Y denotes manufacturing origin and XXXX denotes manufacturing lot number. The value of “Y” will depend on the assembly location of the device.

19. A capacitor of value 0.1 μF or higher between VDD and GND is required. An additional 10 μF capacitor between VDD and GND is required for the best phase jitter performance.

Dimensions and Patterns — 2.5 x 2.0 mm x mm



Dimensions and Patterns — 3.2 x 2.5 mm x mm



Additional Information

Table 20. Additional Information

Document	Description	Download Link
ECCN #: EAR99	Five character designation used on the commerce Control List (CCL) to identify dual use items for export control purposes.	—
HTS Classification Code: 8542.39.0000	A Harmonized Tariff Schedule (HTS) code developed by the World Customs Organization to classify/define internationally traded goods.	—
Manufacturing Notes	Tape & Reel dimension, reflow profile and other manufacturing related info	https://www.sitime.com/support/resource-library/manufacturing-notes-sitime-products
Termination Techniques	Termination design recommendations	http://www.sitime.com/support/application-notes
Layout Techniques	Layout recommendations	http://www.sitime.com/support/application-notes
Evaluation Boards	SiT6760EB	https://www.sitime.com/support/resource-library/user-manuals/sit6760eb-evaluation-board-user-manual

Revision History

Table 21. Revision History

Revision	Release Date	Change Summary
1.0	27-Aug-2024	Datasheet for production release

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